

# The RF Line

## NPN Silicon

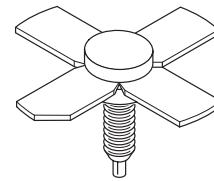
### RF Power Transistor

... designed primarily for wideband large-signal driver and predriver amplifier stages in 200–500 MHz frequency range.

- Guaranteed Performance at 400 MHz, 28 Vdc  
Output Power = 10 Watts  
Power Gain = 12 dB Min  
Efficiency = 50% Min
- 100% Tested for Load Mismatch at all Phase Angles with 30:1 VSWR
- Gold Metallization System for High Reliability
- Computer-Controlled Wirebonding Gives Consistent Input Impedance

**MRF321**

10 W, 400 MHz  
RF POWER  
TRANSISTOR  
NPN SILICON



CASE 244-04, STYLE 1

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CEO}$	33	Vdc
Collector-Base Voltage	$V_{CBO}$	60	Vdc
Emitter-Base Voltage	$V_{EBO}$	4.0	Vdc
Collector Current — Continuous — Peak	$I_C$	1.1 1.5	mAdc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ (1) Derate above $25^\circ\text{C}$	$P_D$	27 160	Watts mW/ $^\circ\text{C}$
Storage Temperature Range	$T_{Stg}$	-65 to +150	$^\circ\text{C}$

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	6.4	$^\circ\text{C}/\text{W}$

#### ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit

#### OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage ( $I_C = 20 \text{ mA}\text{dc}$ , $I_B = 0$ )	$V_{(BR)CEO}$	33	—	—	Vdc
Collector-Emitter Breakdown Voltage ( $I_C = 20 \text{ mA}\text{dc}$ , $V_{BE} = 0$ )	$V_{(BR)CES}$	60	—	—	Vdc
Collector-Base Breakdown Voltage ( $I_C = 20 \text{ mA}\text{dc}$ , $I_E = 0$ )	$V_{(BR)CBO}$	60	—	—	Vdc
Emitter-Base Breakdown Voltage ( $I_E = 2.0 \text{ mA}\text{dc}$ , $I_C = 0$ )	$V_{(BR)EBO}$	4.0	—	—	Vdc
Collector Cutoff Current ( $V_{CB} = 30 \text{ Vdc}$ , $I_E = 0$ )	$I_{CBO}$	—	—	1.0	mA

#### ON CHARACTERISTICS

DC Current Gain ( $I_C = 500 \text{ mA}$ , $V_{CE} = 5.0 \text{ Vdc}$ )	$h_{FE}$	20	—	80	—

NOTE:

(continued)

1. This device is designed for RF operation. The total device dissipation rating applies only when the device is operated as an RF amplifier.

**tyco / Electronics**

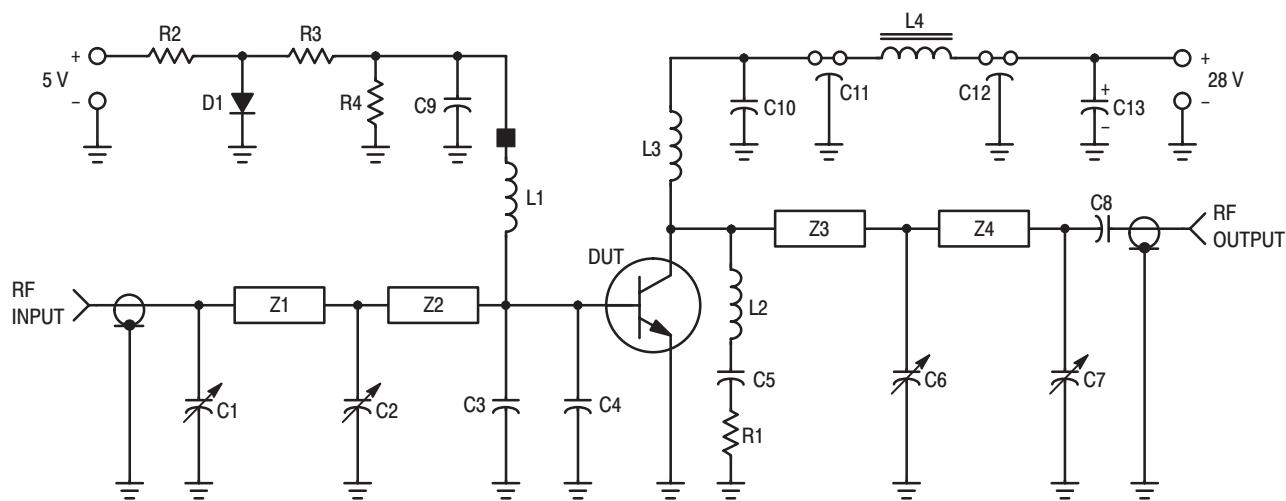
**M/A-COM**

**ELECTRICAL CHARACTERISTICS — continued** ( $T_C = 25^\circ\text{C}$  unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>DYNAMIC CHARACTERISTICS</b>					
Output Capacitance ( $V_{CB} = 28 \text{ Vdc}$ , $I_E = 0$ , $f = 1.0 \text{ MHz}$ )	$C_{ob}$	—	10	12	pF

**FUNCTIONAL TESTS** (Figure 1)

Common-Emitter Amplifier Power Gain ( $V_{CC} = 28 \text{ Vdc}$ , $P_{out} = 10 \text{ W}$ , $f = 400 \text{ MHz}$ )	$G_{PE}$	12	13	—	dB
Collector Efficiency ( $V_{CC} = 28 \text{ Vdc}$ , $P_{out} = 10 \text{ W}$ , $f = 400 \text{ MHz}$ )	$\eta$	50	60	—	%
Load Mismatch ( $V_{CC} = 28 \text{ Vdc}$ , $P_{out} = 10 \text{ W}$ , $f = 400 \text{ MHz}$ , VSWR = 30:1 all phase angles)	$\Psi$	No Degradation in Output Power			



C1, C2, C3 — 1.0–20 pF Johanson Trimmer (JMC 5501)

C3, C4 — 47 pF ATC Chip Capacitor

C5, C10 — 0.1  $\mu\text{F}$  Erie Redcap

C7 — 0.5–10 pF Johanson Trimmer (JMC 5201)

C8 — 0.018  $\mu\text{F}$  Vitramon Chip Capacitor

C9 — 200 pF UNELCO Capacitor

C11, C12 — 680 pF Feedthru

C13 — 1.0  $\mu\text{F}$ , 50 Volt Tantalum Capacitor

D1 — 1N4001

L1 — 0.33  $\mu\text{H}$  Molded Choke with Ferroxcube Bead  
(Ferroxcube 56–590–65/4B) on Ground End of Coil

L2 — 4 Turns #20 Enamel, 1/8" ID

L3 — 6 Turns #20 Enamel, 1/4" ID

L4 — Ferroxcube VK200–19/4B

R1 — 5.1  $\Omega$ , 1/4 Watt

R2 — 120  $\Omega$ , 1.0 Watt

R3 — 20  $\Omega$ , 1/2 Watt

R4 — 47  $\Omega$ , 1/2 Watt

Z1 — Microstrip 0.1" W x 1.35" L

Z2 — Microstrip 0.1" W x 0.55" L

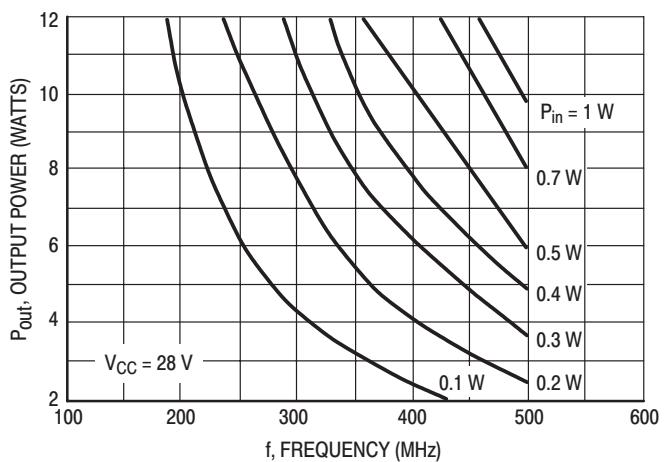
Z3 — Microstrip 0.1" W x 0.8" L

Z4 — Microstrip 0.1" W x 1.75" L

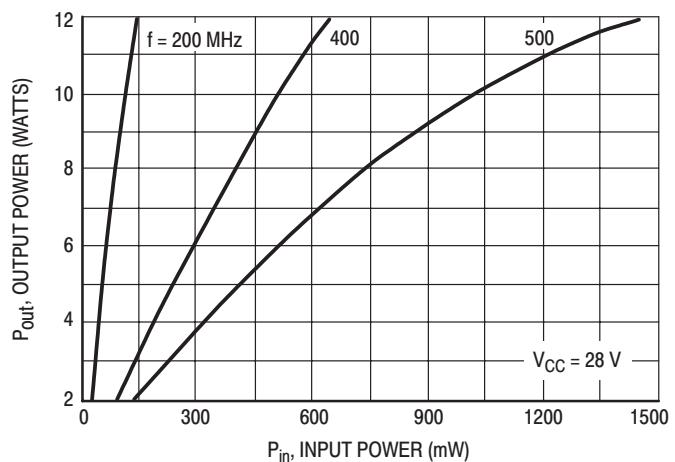
Board — Glass Teflon,  $\epsilon_R = 2.56$ ,  $t = 0.062"$

Input/Output Connectors — Type N

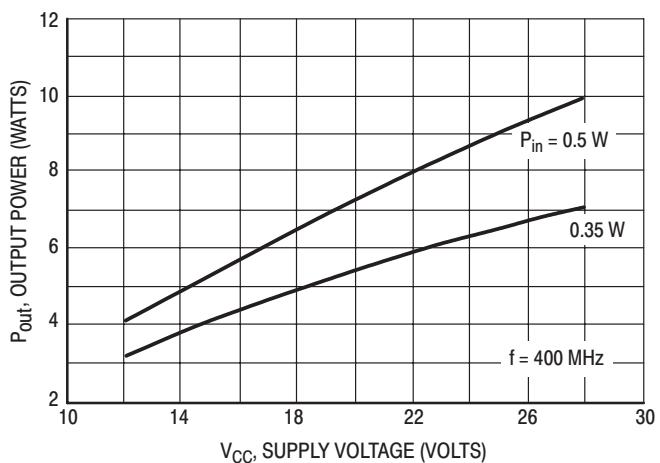
**Figure 1. 400 MHz Test Circuit Schematic**



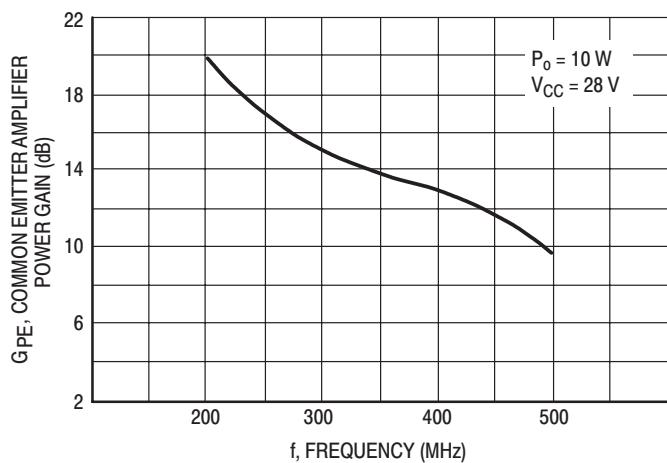
**Figure 2. Output Power versus Frequency**



**Figure 3. Output Power versus Input Power**



**Figure 4. Output Power versus Supply Voltage**



**Figure 5. Power Gain versus Frequency**

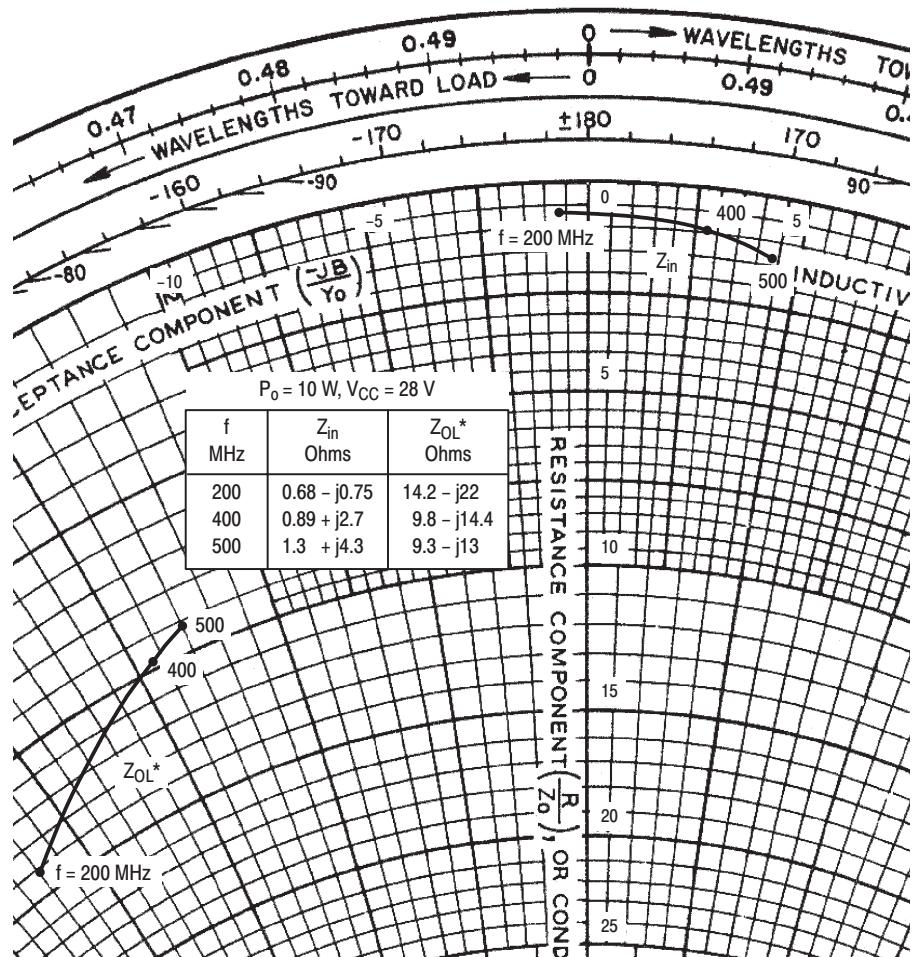
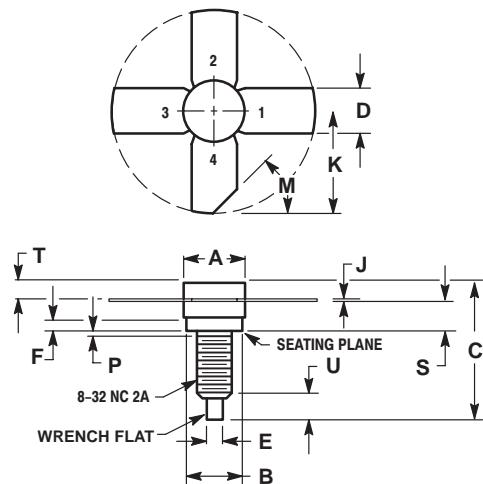


Figure 6. Series Equivalent Impedance

## PACKAGE DIMENSIONS



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	7.06	7.26	0.278	0.286
B	6.20	6.50	0.244	0.256
C	14.99	16.51	0.590	0.650
D	5.46	5.96	0.215	0.235
E	1.40	1.65	0.055	0.065
G	1.52	---	0.060	---
J	0.08	0.17	0.003	0.007
K	11.05	---	0.435	---
M	45° NOM		45° NOM	
P	---	1.27	---	0.050
S	3.00	3.25	0.118	0.128
T	1.40	1.77	0.055	0.070
U	2.92	3.68	0.115	0.145

STYLE 1:  
 PIN 1. Emitter  
 2. Base  
 3. Emitter  
 4. Collector

**CASE 244-04**  
**ISSUE J**

Specifications subject to change without notice.

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